

SBG1025L - SBG1030L

10A SCHOTTKY BARRIER RECTIFIER

Features

- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- High Surge Capability
- Very Low Forward Voltage Drop
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Applications

NOT RECOMMENDED

FOR NEW DESIGN

• Lead Free Finish, RoHS Compliant (Note 2)

Mechanical Data

- Case: D2PAK
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Finish Tin. Solderable per MIL-STD-202, Method 208 (3)
- Polarity: See Diagram
- Marking: Type Number
- Ordering Information: See Page 2
- Weight: 1.7 grams (approximate)



Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	SBG1025L	SBG1030L	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	25	30	V
RMS Reverse Voltage	V _{R(RMS)}	18	21	V
Average Rectified Output Current @ T _C = 120°C	lo	10		А
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave Superimposed on Rated Load	IFSM	20	А	
Typical Thermal Resistance Junction to Case (Note 1)	R ₀ JC	3.0		°C/W
Operating Temperature Range	Ti	-65 to	°C	
Storage Temperature Range	T _{STG}	-65 to	۰C	

Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
Reverse Breakdown Voltage (Note 3) SBG1025L	V	25			V	I _R = 1mA		
SBG1030L	V _{(BR)R}	30		_	V	$I_R = IIIIA$		
Forward Voltage	V _{FM}			0.45	V	@ $I_F = 10A$, $T_C = 25^{\circ}C$		
			0.34	0.36		@ $I_F = 10A$, $T_C = 125^{\circ}C$		
		—	—	0.55		@ $I_F = 20A, T_C = 25^{\circ}C$		
		_	0.48	0.50		@ $I_F = 20A$, $T_C = 125^{\circ}C$		
Peak Reverse Current	I _{RM}	1		_	_	1.0	mA	@ $T_{C} = 25^{\circ}C$
at Rated DC Blocking Voltage (Note 3)		_	150	260	ША	@ T _C = 125°C		
Turpical Total Capacitance	Ст	_	350		рF	$f = 1.0MHz, V_R = 4.0V DC,$		
Typical Total Capacitance					330		μг	Per Element

Notes: 1. Thermal resistance: junction to case mounted on heat sink

2. RoHS revision 13.2.2003. High temperature solder exemption applied, see EU Directive Annex Note 7.

3. Short duration pulse test used to minimize self-heating effect.





Ordering Information (Note 4)

Device	Packaging	Shipping
SBG1025L-F	D ² PAK	50/Tube
SBG1025L-T-F	D ² PAK	800/Tape & Reel
SBG1030L-F	D ² PAK	50/Tube
SBG1030L-T-F	D ² PAK	800/Tape & Reel

Notes: 4. For packaging details, visit our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



SBG10XXL = Product type marking code (SBG1025L or SBG1030L) ⁾ = Manufacturers' code marking YWW = Date code marking Y = Last digit of year ex: 2 for 2002 WW = Week code 01 to 52

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